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U.S. Department of Commerce Patent And Trademark Office

OMB No. 0651-0011 (exp. 4/94)	101740200
To the Honorable Commissioner of Patents and Trademarks: Please reco	ord the attached original document or copy thereof.
1. Name of conveying party(ies):	2. Name and address of receiving party(ies):
Stuart L. FRIEDMAN Date OF 140 / OF 200 / OF 200 / OF 260 / OF 26	Name: ETEC SYSTEMS, INC. Internal Address: 26460 Corporate Avenue
Additional name(s) of conveying party(ies) attached?YesX_No	Street Address:
3. Nature of conveyance:	
X Assignment Merger	City: Hayward State: CA Zip: 94545
Security Agreement Change of Name Other	Additional name(s) & address(es) attached?Yes _XNo
Execution Date: SEE ABOVE	
B. Patent No.(s) Additional numbers attached?Yes _X_No 5. Name and address of party to whom correspondence concerning document should be mailed: Name:Patent Counsel Internal Address:APPLIED MATERIALS, INC.	
	X Authorized to be charged to deposit account 50-1074
Street Address: P.O. Box 450-A	8. Deposit account number: 50-1074
City: Santa Clara State: CA Zip: 95052	
DO N	OT USE THIS SPAGE
9. Statement and signature. To the best of my knowledge and belief, the foregoing information is ROBERT W. MULCAHY Reg. No. 25,436 Name of Person Signing Signa	the and farfect and art quached copy is firme copy of the original document.

Mail documents to be recorded with required cover sheet information to: Commissioner of Patents & Trademarks, Box Assignments

Washington, D.C. 20231

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FORM PTO-1595 (Rev. 6-93)

ASSIGNMENT FOR APPLICATION FOR PATENT

WHEREAS:

Names and Addresses of Inventors:

1)	Stuart L. FRIEDMAN 2754 Greer Road Palo Alto, CA 94303	2)	Tai-Hon Philip CHANG 1105 Nimitz Lane Foster City, CA 94404
3)	Ming L. YU 41019 Pajaro Drive Fremont, CA 94539	4)	

(hereinafter referred to as Assignors), have invented a certain invention entitled:

"TANDEM MICROCHANI	NEL PLATE AND SOLID STATE ELECTRON DETECTOR	₹"
* *	ers Patent in the United States was filed on	,
under Serial No	, executed on even date herewith; and	

WHEREAS, ETEC SYSTEMS, INC., having a place of business at 26460 Corporate Avenue, Hayward, CA 94545 (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title and interest in and to said application (hereinafter referred to as Application), and the invention disclosed therein (hereinafter referred to as Invention), and in and to all embodiments of the Invention, heretofore conceived, made or discovered by said Assignors, and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter referred to as Patents) thereon granted in any and all countries and groups of countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Assignors to have been received in full from said Assignee:

- 1. Said Assignors hereby sell, assign, transfer and convey to Assignee the full and exclusive right, title and interest (a) in and to said Application and said Invention; (b) in and to all rights to apply for patents on said Invention in any and all countries pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all Applications filed and any and all Patents granted on said Invention in any and all countries and groups of countries, including each and every Application filed and each and every Patent granted on any application which is a division, substitution, or continuation of said Application; and (d) in and to each and every reissue or extension of any of said Patents.
- 2. Said Assignors hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest to said Invention herein conveyed in any and all countries and groups of countries. Such cooperation by said Assignors shall include prompt production of pertinent facts and documents, giving testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said Invention; (d) for filing and prosecuting applications for reissuance

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of any of said Patents; (e) for interference or other priority proceedings involving said Invention; and (f) for legal proceedings involving said Invention and any application therefor and any Patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Assignors in providing such cooperation shall be paid for by said Assignee.

- 3. The term and covenants of this agreement shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Assignors, their respective heirs, legal representatives and assigns.
- 4. Said Assignors hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignors have executed and delivered this instrument to said Assignee on the dates indicated below.

1)	5/14/01, 2001			· (
,		Stuart L. F	RIEDMAN	1	

2)	5/20/0/ ,20	Justin Justin	
,	7	Tai-Hon Philip CHANG	

3)	4/26/01.2001	Meng La Ja		
,		Ming L/YU		